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IN THE CLAIMS:

Please cancel Claims 13-18 and 20-27 without prejudice or disclaimer of the subject matter recited therein.

Please add new Claims 28-31 as follows.

Claims 1-27. (Cancelled).

28. (New) A method of manufacturing an image display apparatus having display devices and an airtight container containing the display devices, comprising a step of bonding a substrate to a frame for forming an airtight space together with the substrate through a seal bonding material containing a low melting point metal, wherein the step of bonding includes:

a step of providing a seal bonding material along a corner between the frame and the substrate formed by setting the frame and the substrate to abut on each other; and a step of heating the seal bonding material to a temperature equal to or higher than a temperature at which the seal bonding material can perform bonding of the substrate to the frame, successively along the corner, wherein the seal bonding material melted by the heating is introduced between opposing surfaces of the frame and the substrate.

 (New) A method of manufacturing an image display apparatus having display devices and an airtight container containing the display devices, comprising a step of

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bonding a substrate to a frame for forming an airtight space together with the substrate through a seal bonding material containing a low melting point metal, wherein the step of bonding includes:

a step of supplying the seal bonding material, heated to a temperature equal to or higher than a temperature at which the seal bonding material can perform bonding of the substrate to the frame, successively along a corner between the frame and the substrate formed by setting the frame and the substrate to abut on each other, wherein the seal bonding material melted by the heating is introduced between opposing surfaces of the frame and the substrate.

- 30. (New) The method according to claim 28, wherein the step of heating is performed within a vacuum atmosphere.
- 31. (New) The method according to claim 28, further comprising a step of forming on a portion, on which the seal bonding material is to be provided, a material of good wettability to the seal bonding material as an underlying film.